4096-word × 8-bit UV Erasable and Programmable Read Only Memory

The HN462532 is a 4096 word by 8 bit erasable and electrically programmable ROM. This device is packaged in a 24-pin, dual-in-line package with transparent lid. The transparent lid allows the user to expose the chip to ultraviolet light to erase the bit pattern, whereby a new pattern can then be written into the device.

FEATURES

Single Power Supply +5V ±5%

Simple Programming Program Voltage: +25V D.C.

Program with One 50ms Pulse

Static No Clocks Required

Inputs and Outputs TTL Compatible During Both Read and Program Modes

Fully Decoded On-Chip Address Decode

Access Time 450ns (Max.)

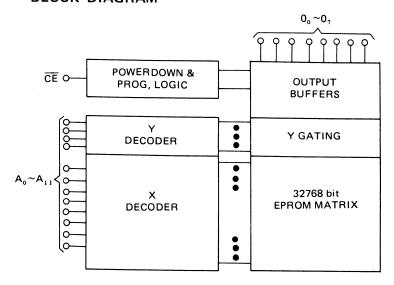
Low Power Dissipation 858mW (Max.) Active Power

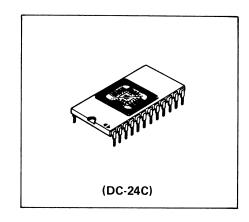
201mW (Max.) Standby Power

• Three State Output OR-Tie Capability

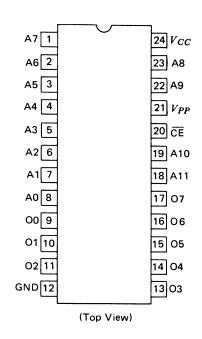
Compatible with TMS2532

■ BLOCK DIAGRAM





■ PIN ARRANGEMENT



■ MODE SELECTION

Pins	CE (20)	<i>V_{PP}</i> (21)	V _{CC} (24)	Outputs (9 to 11, 13 to 17)
Read	V_{IL}	+5	+5	Dout
Stand by	V_{IH}	+5	+5	High Z
Program	Pulsed VIH to VIL	+25	+5	Din
Program Inhibit	V_{IH}	+25	+5	High Z

■ ABSOLUTE MAXIMUM RATINGS

Item	Symbol	Value	Unit V	
All Input and Output Voltages*	V_{IN}, V_{out}	-0.3 to +7		
VPP Voltage*	V_{PP}	-0.3 to +28	V	
Operating Temperature Range	T_{opr}	0 to +70	°C	
Storage Temperature Range	T _{stg}	-65 to +125	°C	

■ READ OPERATION

• D.C. AND OPERATING CHARACTERISTICS (T_a = 0 to +70°C, V_{CC} = 5V ±5%, V_{PP} = V_{CC} ±0.6V)

Parameter	Symbol	Test Conditions	min.	typ.	max.	Unit
Input Leakage Current	I_{LI}	V _{in} = 5.25 V	_		10	μΑ
Output Leakage Current	I_{LO}	Vout = 5.25 V / 0.4 V	_	-	10	μΑ
Vpp Current	I _{PP} 1	<i>VPP</i> = 5.85 V	_	_	12	mA
VCC Current (Standby)	Icc1	CE = V _{IH}	_		25	mA
VCC Current (Active)	Icc2	CE = V _{IL}	_		150	mA
Input Low Voltage	V_{IL}		-0.1	_	0.8	٧
Input High Voltage	V_{IH}		2.0	_	V _{CC} +1	V
Output Low Voltage	VOL	<i>I_{OL}</i> = 2.1 mA	_	_	0.4	V
Output High Voltage	Voн	<i>I_{OH}</i> = -400μA	2.4	_	_	V

Notes: Vcc must be applied simultaneously or before Vpp and removed simultaneously or after Vpp.

• AC CHARACTERISTICS ($T_a = 0 \text{ to } +70^{\circ}\text{C}$, $V_{CC} = 5\text{V} \pm 5\%$, $V_{PP} = V_{CC} \pm 0.6\text{V}$)

Parameter	Symbol	Test Conditions	min.	typ.	max.	Unit
Address to Output Delay	†ACC	$\overline{CE} = V_{IL}$	_	_	450	ns
CE to Output Delay	t _{CE}		_		450	ns
CE High to Output Float	t_{DF}		0	_	100	ns
Address to Output Hold	t _{OH}	$\overline{CE} = V_{IL}$	0	_	-	ns

• SWITCHING CHARACTERISTICS

Test Conditions

Input Pulse Levels:

0.8V to 2.2V

Input Rise and Fall Times:

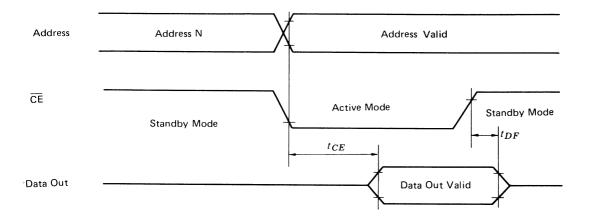
≤20ns

Output Load:

1TTL Gate + 100pF

Reference Level for Measuring Timing:

Inputs; 1V and 2V, Outputs; 0.8V and 2V



• CAPACITANCE $(T_a = 25^{\circ}C, f = 1 \text{ MHz})$

Parameter	Symbol	Test Conditions	min.	typ.	max.	Unit
Input Capacitance	Cin	Vin = 0 V	_		6	pF
Output Capacitance	Cout	Vout = 0V	_	_	12	pF

■ PROGRAMMING OPERATION

• DC PROGRAMMING CHARACTERISTICS ($T_a = 25^{\circ}\text{C} \pm 5^{\circ}\text{C}$, $V_{CC} = 5\text{V} \pm 5\%$, $V_{PP} = 25\text{V} \pm 1\text{V}$)

Parameter	Symbol	Test Conditions	min.	typ.	max.	Unit
Input Leakage Current	I_{LI}	$V_{in} = 5.25 \text{V} / 0.4 \text{V}$	_	_	10	μА
VPP Supply Current During Programming	IPP2	$\overline{CE} = V_{IL}$	_	_	30	mA
VCC Supply Current	Icc		_	_	150	mA
Input Low Level	V_{IL}		-0.1	_	0.8	V
Input High Level	V_{IH}		2.0	_	V _{CC} +1	V

• AC PROGRAMMING CHARACTERISTICS ($T_a = 25^{\circ}\text{C} \pm 5^{\circ}\text{C}$, $V_{CC} = 5\text{V} \pm 5\%$, $V_{PP} = 25\text{V} \pm 1\text{V}$)

Parameter	Symbol	Test Conditions	min.	typ.	max.	Unit
Address Setup Time	t_{AS}		2	_	_	μs
Data Setup Time	t_{DS}		2	_	_	μs
Address Hold Time	t _{AH}		2	_	_	μs
Data Hold Time	t _{DH}	VI CONTRACTOR OF THE CONTRACTO	2	_	_	μs
Setup Time from Vpp	tVPPS		0	<u> </u>	_	ns
Program Pulse Hold Time	tPRH		0	_	_	ns
V _{PP} Hold Time	t _{VPPH}	The second secon	0	_	_	ns
Program Pulse Width	t_{PW}		45	50	55	ms
Program Pulse Time	tPRT		5	_	 -	ns
Program Pulse Time	t_{PFT}		5	_	_	ns

Note: V_{CC} must be applied simultaneously or before V_{PP} and removed simultaneously or after V_{PP} .

• SWITCHING CHARACTERISTICS

Test Conditions

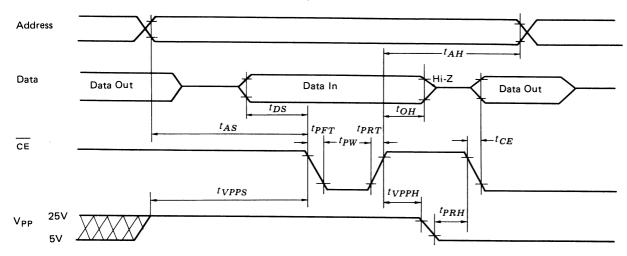
Input Pulse Level: 0.8V to 2.2V

Input Rise and Fall Times: ≤20ns

Output Load: 1TTL Gate + 100pF

Reference Level for Measuring Timing: Inputs; 1V and 2V,

Outputs; 0.8V and 2V



●ERASE

Erasure of HN462532 is performed by exposure to ultraviolet light with a wavelength of 2537\AA , and all the output data are changed to "1" after this erasure procedure.

The minimum integrated close (i.e., UV intensity x exposure time) for erasure is $15W \cdot sec/cm^2$.